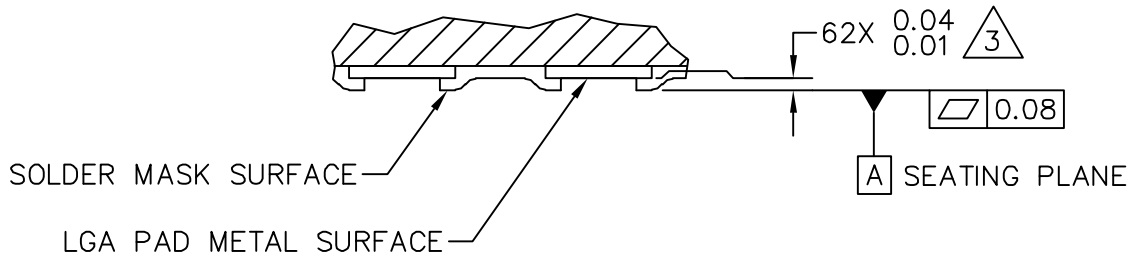
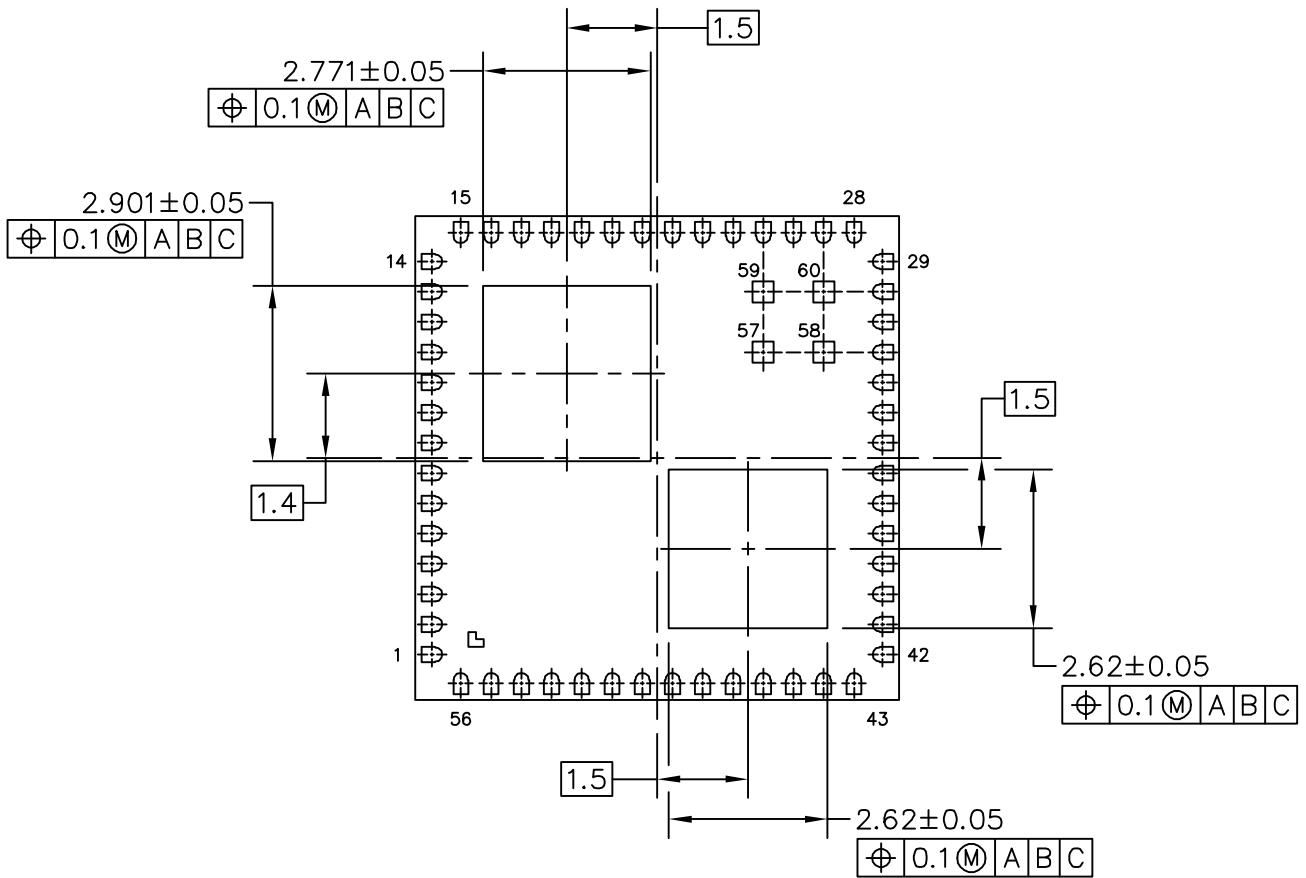


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TITLE: PLGA, THIN PROFILE, FINE PITCH, 60 I/O, 8 X 8 PKG, 0.5 MM PITCH (MAP)	DOCUMENT NO: 98ASA00302D	REV: A
	STANDARD: NON-JEDEC	
	SOT1552-1	07 JAN 2016



DETAIL D
VIEW ROTATED 90° CW



BOTTOM VIEW

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	STANDARD: NON-JEDEC	
	SOT1552-1	07 JAN 2016



NOTES:

1. ALL DIMENSIONS IN MILLIMETERS.

2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.

3. DIMENSION APPLIES TO ALL LEADS AND FLAG AREA.

4. PARALLELISM MEASUREMENT SHALL EXCLUDE ANY EFFECT OF MARK ON TOP SURFACE OF PACKAGE.

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